

AOZ8328DI

Low Capacitance 2.5 V TVS Diode

General Description

The AOZ8328DI is a transient voltage suppressor array designed to protect high speed data lines from ESD and lightning.

This AOZ8328DI incorporates eight surge rated, low capacitance steering diodes and a TVS in a single package. During transient conditions, the steering diodes direct the transient to either the positive side of the power supply line or to ground. The AOZ8328DI may be used to meet the ESD immunity requirements of IEC 61000-4-2, Level 4 and IEC 61000-4-5. The TVS diodes provide effective suppression of ESD voltages: ±30 kV (air discharge) and ±30 kV (contact discharge).

The AOZ8328DI comes in a Halogen Free and RoHS compliant DFN-10 3.0 mm x 2.0 mm package and is rated over a -40°C to +125°C ambient temperature range. The AOZ8328DI is compatible with both lead free and SnPb assembly techniques. The small size, low capacitance and high ESD protection makes the AOZ8328DI ideal for protecting high speed video and data communication interfaces.

Features

- ESD protection for high-speed data lines:
 - IEC 61000-4-2, level 4 (ESD) immunity test
 - ±30 kV (air discharge) and ±30 kV (contact discharge)
 - IEC 61000-4-4 (EFT) 40 A (5/50 ns)
 - IEC 61000-4-5 (Lightning) 32 A
 - Human Body Model (HBM) ±30 kV
- Small package saves board space
- Low insertion loss
- Protects four I/O lines
- Low clamping voltage
- Low operating voltage: 2.5 V
- Green product
- Pb-free device

Applications

- 10/100/1000 Ethernet
- USB 2.0 power and data line protection
- Video graphics cards
- Monitors and flat panel displays
- Digital Video Interface (DVI)
- T1/E1 telecom ports



Typical Application

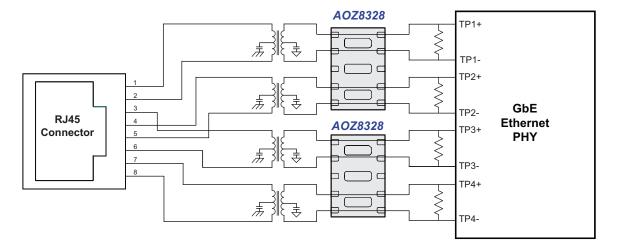


Figure 1. 10/100/1000 Ethernet Port Connection



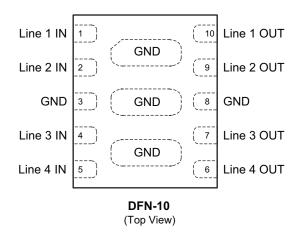
Ordering Information

Part Number	Ambient Temperature Range	Package	Environmental		
AOZ8328DI	-40°C to +125°C	3.0 mm x 2.0 mm DFN-10	Green Product		

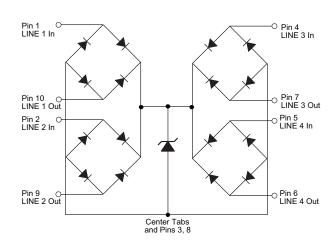


AOS Green Products (with "L" suffix) use reduced levels of Halogens, and are also RoHS compliant. Please visit www.aosmd.com/media/AOSGreenPolicy.pdf for additional information.

Pin Configuration



Schematic



Absolute Maximum Ratings

Exceeding the Absolute Maximum ratings may damage the device.

Parameter	Rating
VP – GND	2.5 V
Peak Pulse Power (P_{PK}), $t_P = 8/20 \mu s^{(1)}$	450 W
Peak Pulse Current (I_{PP}), $t_P = 8/20 \ \mu s^{(1)}$	32 A
Storage Temperature (T _S)	-65°C to +150°C
ESD Rating per IEC61000-4-2, Contact ⁽²⁾	±30 kV
ESD Rating per IEC61000-4-2, Air ⁽²⁾	±30 kV
ESD Rating per Human Body Model ⁽³⁾	±30 kV

Notes:

- 1. Ratings with 2 pins connected together per the recommended configuration (ie. pin 1 connected to pin 10, pin 2 connected to pin 9, pin 4 connected to pin 7, and pin 5 connected to pin 6).
- 2. IEC 61000-4-2 discharge with C_Discharge = 150 pF, R_Discharge = 330 Ω .
- 3. Human Body Discharge per MIL-STD-883, Method 3015 $C_{Discharge}$ = 100 pF, $R_{Discharge}$ = 1.5 k Ω .

Maximum Operating Ratings

Parameter	Rating
Junction Temperature (T _{,I})	-40 °C to +125 °C

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Electrical Characteristics

 $T_A = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
V _{RWM}	Reverse Working Voltage	Between any I/O pin and GND ⁽⁴⁾			2.5	V
I _R	Reverse Leakage Current	V _{RWM} = 2.5 V, between any I/O pin and GND			1	μA
V _{CL}	Channel Clamp Voltage	$I_{PP} = 5 \text{ A}$, tp = 8/20 µs, any I/O pin to Ground ⁽³⁾				
	Positive Transients				4.5	V
	Negative Transient				-4.5	V
	Channel Clamp Voltage	I _{PP} = 10 A, tp = 8/20 μs, any I/O pin to				
	Positive Transients	Ground ⁽³⁾			8	V
	Negative Transient				-8	V
	Channel Clamp Voltage	I _{PP} = 25 A, tp = 8/20 μs, any I/O pin to				
	Positive Transients	Ground ⁽³⁾			16	V
	Negative Transient				-18	V
C _j	Junction Capacitance	V _R = 0 V, f = 1 MHz, any I/O pin to Ground		2.8	4	pF
		V _R = 0 V, f = 1 MHz, between I/O pins ⁽³⁾		1.4		pF

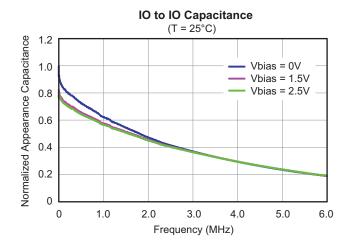
Notes:

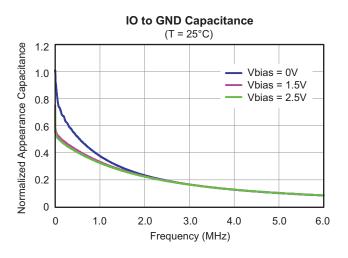
- 3. These specifications are guaranteed by design.
- $4. \ The \ working \ peak \ reverse \ voltage, \ V_{RWM}, \ should \ be \ equal \ to \ or \ greater \ than \ the \ DC \ or \ continuous \ peak \ operating \ voltage \ level.$

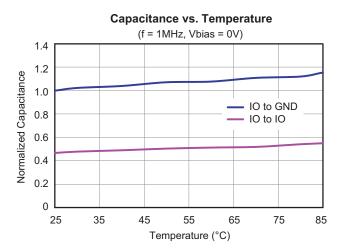
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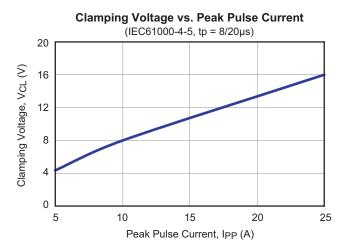


Typical Performance Characteristics



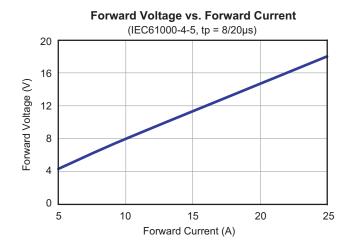








Typical Performance Characteristics (Continued)







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Application Information

The AOZ8328DI TVS is design to protect four data lines from fast damaging transient over-voltage by clamping the over-voltage to a reference. When the transient on a protected data line exceeds the reference voltage, the steering diode is forward bias and conducts harmful ESD transients away from the sensitive circuitry under protection.

PCB Layout Guidelines

Printed circuit board layout is the key to achieving the highest level of surge immunity on power and data lines. The location of the protection devices on the PCB is the simplest and most important design rule to follow. The AOZ8328DI devices should be located as close as possible to the noise source. The placement of the AOZ8328DI devices should be used on all data and power lines that enter or exit the PCB at the I/O connector. In most systems, surge pulses occur on data and power lines that enter the PCB through the I/O connector. Placing the AOZ8328DI devices as close as possible to the noise source ensures that a surge voltage will be clamped before the pulse can be coupled into adjacent PCB traces. In addition, the PCB should use the shortest possible traces. A short trace length equates to low impedance, which ensures that the surge energy will be dissipated by the AOZ8328DI device. Long signal traces will act as antennas to receive energy from fields that are produced by the ESD pulse. By keeping line lengths as short as possible, the efficiency of the line to act as an antenna for ESD related fields is reduced.

Minimize interconnecting line lengths by placing devices with the most interconnect as close together as possible. The protection circuits should shunt the surge voltage to either the reference or chassis ground. Shunting the surge voltage directly to the IC's signal ground can cause ground bounce. The clamping performance of TVS diodes on a single ground PCB can be improved by minimizing the impedance with relatively short and wide ground traces. The PCB layout and IC package parasitic

inductances can cause significant overshoot to the TVS's clamping voltage. The inductance of the PCB can be reduced by using short trace lengths and multiple layers with separate ground and power planes. One effective method to minimize loop problems is to incorporate a ground plane in the PCB design. The AOZ8328DI low capacitance TVS is designed to protect four high speed data transmission lines from transient over-voltages by clamping them to a fixed reference. The low inductance and construction minimizes voltage overshoot during high current surges. When the voltage on the protected line exceeds the reference voltage the internal steering diodes are forward biased, conducting the transient current away from the sensitive circuitry.

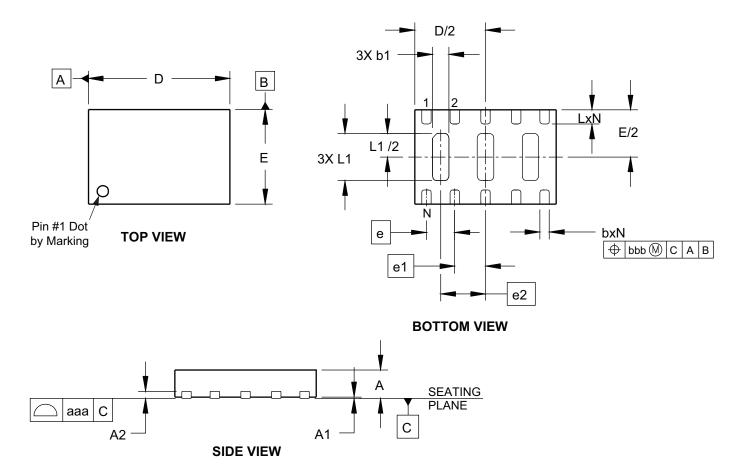
Good circuit board layout is critical for the suppression of ESD induced transients. The following guidelines are recommended:

- 1. Place the TVS near the I/O terminals or connectors to restrict transient coupling.
- 2. Fill unused portions of the PCB with ground plane.
- 3. Minimize the path length between the TVS and the protected line.
- 4. Minimize all conductive loops including power and ground loops.
- 5. The ESD transient return path to ground should be kept as short as possible.
- 6. Never run critical signals near board edges.
- 7. Use ground planes whenever possible.
- 8. Avoid running critical signal traces (clocks, resets, etc.) near PCB edges.
- 9. Separate chassis ground traces from components and signal traces by at least 4 mm.
- 10. Keep the chassis ground trace length-to-width ratio < 5:1 to minimize inductance.
- 11. Protect all external connections with TVS diodes.

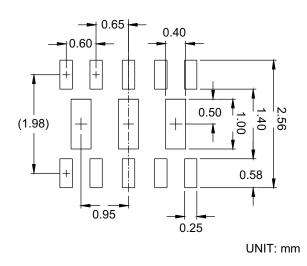
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Package Dimensions, DFN 3.0 x 2.0



RECOMMENDED LAND PATTERN



Dimensions in millimeters

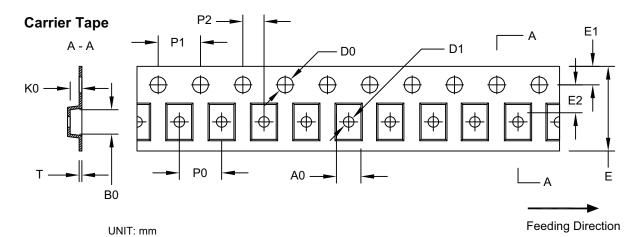
Symbols	Min.	Nom.	Max.		
Α	0.50	0.60	0.65		
A1	0.00	0.03	0.05		
A2		(0.15)			
b	0.15	0.20	0.25		
b1	0.25	0.35	0.45		
D	2.90	3.10			
Е	1.90 2.00 2.10				
е	0.60 BSC				
e1	0.65 BSC				
e2	0.95 BSC				
L	0.25 0.30 0.35				
L1	0.95	1.00	1.05		
Ν	10.00				
aaa	0.08				
bbb		0.10			

Note:

- 1. Controlling dimensions are in millimeters. Coverted inch dimensions are not necessarily exact.
- 2. The land pattern is only for reference.

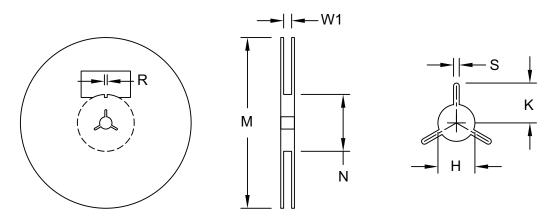


Tape and Reel Dimensions, DFN 3.0 x 2.0



Package	A0	В0	K0	D0	D1	E	E1	E2	P0	P1	P2	P2
DFN	2.20	3.15	0.76	1.50	1.00	8.00	1.75	3.50	4.00	4.00	2.00	0.20
3x2_10L	±0.05	±0.05	±0.05	+0.1/-0.0	+0.05	+0.3/-0.1	±0.10	±0.05	±0.10	±0.10	±0.05	±0.02

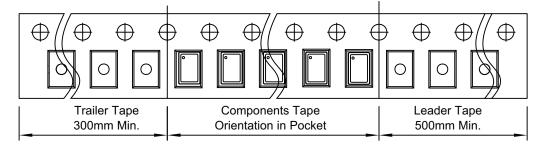
Reel



UNIT: mm

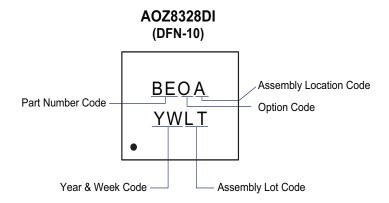
Tape Size	Reel Size	М	N	W1	Н	S	K	R
12mm	ø180	ø180 ±0.5	60 ±0.5	8.4 +0.5/-0.0	13.0 ±0.2	1.5 Min.	13.5 Min.	3.0 ±0.5

Leader / Trailer & Orientation





Part Marking



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